

LM2901B-Q1、LM2901x-Q1 汽车类四路比较器

1 特性

- 符合汽车应用要求
- 具有符合 AEC-Q100 标准的下列特性：
 - 器件温度等级 1：-40°C 至 125°C 环境温度范围
 - 器件 HBM ESD 分类等级：
 - “AV”版本为 1C 级
 - 所有其他版本为 2 级
 - 器件 CDM ESD 分类等级 C3
- 改进了“B”器件的 2kV HBM ESD
- 单电源或双电源
- 独立于电源电压的低电源电流：
 - 每个比较器 200uA (典型值) (“B”版本)
- 低输入偏置电流：3.5nA (典型值) (“B”器件)
- 低输入失调电流：0.5nA (典型值) (“B”器件)
- 低输入失调电压：±0.37mV (典型值) (“B”器件)
- 共模输入电压范围包括接地
- 差动输入电压范围等于最大额定电源电压：±36V
- 输出与 TTL、MOS 和 CMOS 兼容
- 有关采用 SOT 封装的单通道版本，请参阅 TL331-Q1 (SLVS969)
- 有关采用多种封装的双通道版本，请参阅 LM2903x-Q1 (SLCS141)
- 提供功能安全型
 - 有助于进行功能安全系统设计的文档

2 应用

- 汽车
 - HEV/EV 和动力总成
 - 信息娱乐系统与仪表组
 - 车身控制模块
- 工业
- 电器

3 说明

LM2901B-Q1 器件是业界通用 LM2901x-Q1 比较器系列的下一代版本。该下一代系列为成本敏感型应用提供了卓越的价值，其特性包括更低的失调电压、更高的电源电压能力、更低的电源电流、更低的输入偏置电流、更低的传播延迟以及更高的 2kV ESD 性能，并提供了直接替代的便利性。

所有器件都包含四个独立的电压比较器，这些比较器可在宽电压范围内运行。如果两个电源的电压差处于 2V 至 36V 范围内且 VCC 比输入共模电压至少高 1.5V，那么也可以使用双电源。输出可以连接到其他集电极开路输出。

“V”版本的工作电压高达 32V，“B”版本的工作电压高达 36V。所有这些器件均符合 -40°C 至 +125°C 的 AEC-Q100 1 级温度范围。

器件信息

器件型号	封装 (1)	封装尺寸 (标称值)
LM2901B-Q1	TSSOP (14)	4.40mm × 5.00mm
LM2901-Q1	SOIC (14)	3.91mm × 8.65mm
LM2901A-Q1		
LM2901AV-Q1	SOT-23 (14)	4.20mm × 2.00mm
LM2901B-Q1 (预发布)	X2QFN (14)	2.00mm × 2.00mm
	WQFN (16)	3.00mm × 3.00mm

(1) 如需了解所有可用封装，请参阅数据表末尾的可订购产品附录。

系列比较表

规格	LM2901B-Q1	LM2901-Q1	LM2901V-Q1	LM2901AV-Q1	单位
电源电压	2 至 36	2 至 30	2 至 32	2 至 32	V
总电源电流 (5V 至 36V (最大值))	0.6 至 0.8	1 至 2.5	1 至 2.5	1 至 2.5	mA
温度范围	-40 至 125	-40 至 125	-40 至 125	-40 至 125	°C
ESD (HBM)	2000	2000	2000	1000	V
失调电压 (整个温度范围内的最大值)	± 5.5	±15	±15	±4	mV
输入偏置电流 (典型值/最大值)	3.5/25	25/250	25/250	25/250	nA
响应时间 (典型值)	1	1.3	1.3	1.3	μsec



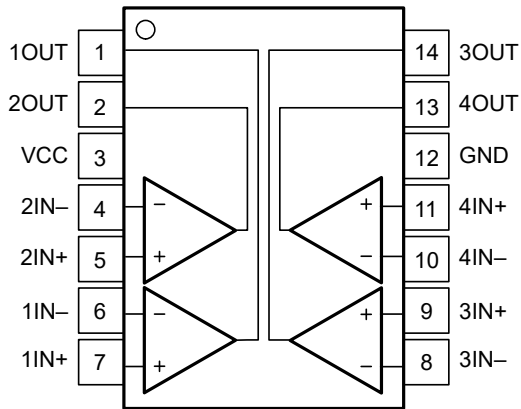
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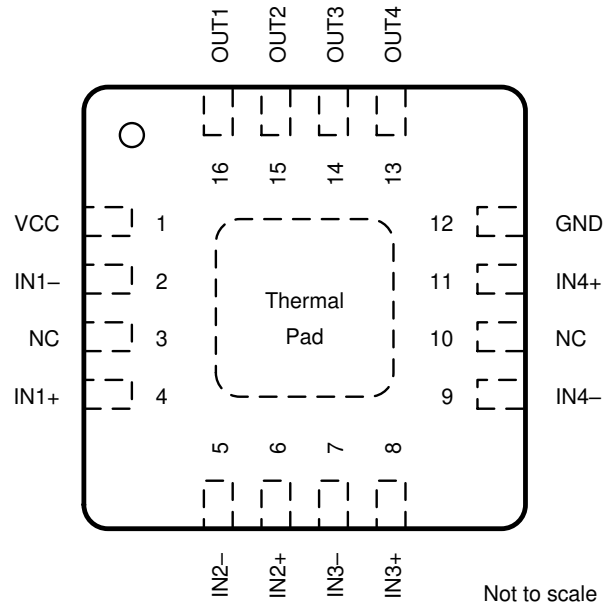
4 Revision History

Changes from Revision F (May 2021) to Revision G (March 2023)	Page
• 更新了“B”版本首页 特性和说明 中的文本.....	1
• 更新了首页 CDM ESD 分类等级.....	1
• 添加了首页 系列产品比较表.....	1
• Added "B" device description, electrical tables, graphs and pinouts throughout.....	5
Changes from Revision E (January 2015) to Revision F (May 2021)	Page
• 更新了首页 HBM ESD 分类等级.....	1
• 更新了整个文档中的表格、图和交叉参考的编号格式.....	1
• Added separate line for 1kV LM2901AV-Q1 HBM in ESD Ratings table.....	6
• Changed incorrect text in Apps Section Feature Description.....	17
• Changed incorrect Layout Example pinout.....	20
Changes from Revision D (April 2008) to Revision E (January 2015)	Page
• 向特性 部分添加了 AEC-Q100 结果.....	1
• 添加了 ESD 等级表、特性说明 部分、器件功能模式、应用和实施 部分、电源相关建议 部分、布局 部分、器件和文档支持 部分以及机械、封装和可订购信息 部分。.....	1
• Added the common-mode voltage note to the V_{ICR} parameter in the <i>Electrical Characteristics</i> table.....	9

5 Pin Configuration and Functions

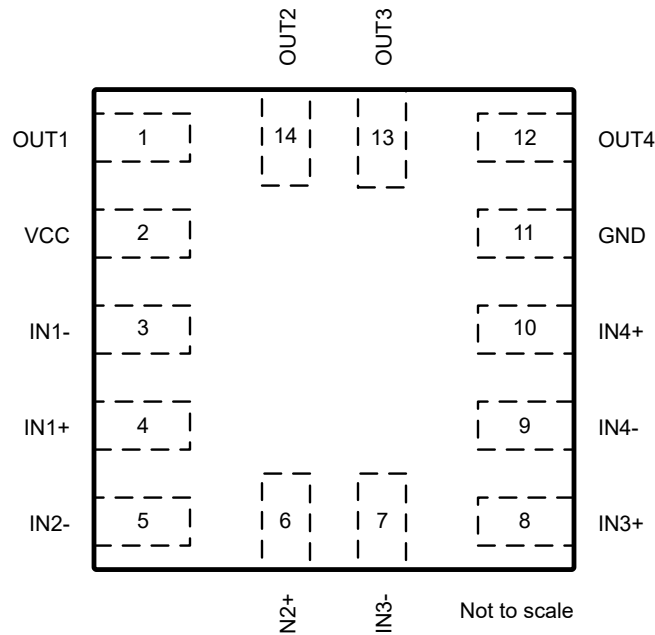


**图 5-1. D, PW and DYY Packages
14-Pin SOIC, TSSOP and SOT-23
Top View**



NOTE: Connect exposed thermal pad directly to GND pin.

**图 5-2. RTE Package
16-Pad WQFN With Exposed Thermal Pad
Top View**



**图 5-3. RUC Package
14-Pad X2QFN
Top View**

表 5-1. Pin Functions

NAME ⁽¹⁾	PIN			I/O	DESCRIPTION
	SOIC, TSSOP, DYY	X2QFN	WQFN		
OUT1 ⁽¹⁾	1	14	16	Output	Output pin of the comparator 2
OUT2 ⁽¹⁾	2	1	15	Output	Output pin of the comparator 1
V _{CC}	3	2	1	—	Positive supply
IN2 – ⁽¹⁾	4	3	5	Input	Negative input pin of the comparator 1
IN2+ ⁽¹⁾	5	4	6	Input	Positive input pin of the comparator 1
IN1 – ⁽¹⁾	6	5	2	Input	Negative input pin of the comparator 2
IN1+ ⁽¹⁾	7	6	4	Input	Positive input pin of the comparator 2
IN3 –	8	7	7	Input	Negative input pin of the comparator 3
IN3+	9	8	8	Input	Positive input pin of the comparator 3
IN4 –	10	9	9	Input	Negative input pin of the comparator 4
IN4+	11	10	11	Input	Positive input pin of the comparator 4
GND	12	11	12	—	Negative supply
OUT4	13	12	13	Output	Output pin of the comparator 4
OUT3	14	13	14	Output	Output pin of the comparator 3
NC	—	—	3	—	No Internal Connection - Leave floating or GND
NC	—	—	10	—	No Internal Connection - Leave floating or GND
Thermal Pad	—	—	PAD	—	Connect directly to GND pin

(1) Some manufacturers transpose the names of channels 1 & 2. Electrically the pinouts are identical, just a difference in channel naming convention.

6 Specifications

6.1 Absolute Maximum Ratings for LM2901B-Q1

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

	MIN	MAX	UNIT
Supply voltage: $V_S = (V+) - (V-)$	-0.3	38	V
Differential input voltage: V_{ID} ⁽²⁾		±38	V
Input pins (IN+, IN-)	-0.3	38	V
Current into input pins (IN+, IN-)		-50	mA
Output pin (OUT)	-0.3	38	V
Output sink current		25	mA
Output short-circuit duration ⁽³⁾		Unlimited	s
Junction temperature, T_J	TBD	150	°C
Storage temperature, T_{stg}	-65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Differential voltages are at IN+ with respect to IN-.
- (3) Short circuits from outputs to V+ can cause excessive heating and eventual destruction.

6.2 Absolute Maximum Ratings for LM2901x-Q1

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

	MIN	MAX	UNIT
Supply voltage, V_{CC} ⁽²⁾		36	V
Differential input voltage, V_{ID} ⁽³⁾		±36	
Input voltage range, V_I (either input)	- 0.3	36	
Output voltage, V_O		36	
Output current, I_O		20	mA
Duration of output short circuit to ground ⁽⁴⁾		Unlimited	
Operating virtual junction temperature, T_J		150	°C
Storage temperature, T_{stg}	- 65	150	°C

- (1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) All voltage values, except differential voltages, are with respect to network ground.
- (3) Differential voltages are at IN+ with respect to IN-.
- (4) Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.

6.3 ESD Ratings for LM2901B-Q1

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per AEC Q100-002 ⁽¹⁾	±2000	V
		Charged-device model (CDM), per AEC Q100-011 ⁽¹⁾	±1000	

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

6.4 ESD Ratings for LM2901x-Q1

			MIN	MAX	UNIT
V _(ESD)	Electrostatic discharge	Human-body model (HBM), per AEC Q100-002 ⁽¹⁾ , (LM2901-Q1, LM2901V-Q1)	-2000	2000	V
		Human-body model (HBM), per AEC Q100-002 ⁽¹⁾ , (LM2901AV-Q1 Only)	-1000	1000	
		Charged-device model (CDM), per AEC Q100-011	-1000	1000	

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

6.5 Recommended Operating Conditions for LM2901B-Q1

over operating free-air temperature range (unless otherwise noted)

	MIN	MAX	UNIT
Supply voltage: $V_S = (V+) - (V-)$	2	36	V
Ambient temperature, T_A , LM2901B-Q1	– 40	125	°C
Input Voltage Range, V_{IVR}	$(V-) - 0.1$	$(V+) - 2.0$	V

6.6 Recommended Operating Conditions for LM2901x-Q1

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage	LM2901-Q1	2	30	V
		LM2901V-Q1, LM2901AV-Q1	2	32	
T _A	Ambient temperature		– 40	125	°C
I _O	Output current (per comparator)		0	4	mA

6.7 Thermal Information for LM2901B-Q1

THERMAL METRIC ⁽¹⁾		LM2901B-Q1					UNIT
		D (SOIC)	PW (TSSOP)	DDY (SOT-23)	RTE (QFN)	RUC (X2QFN)	
		14 PINS	14 PINS	14 PINS	16 PINS	14 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	111.2	136.6				°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	66.9	66.6				
R _{θJB}	Junction-to-board thermal resistance	67.8	79.8				
ψ _{JT}	Junction-to-top characterization parameter	28.0	17.8				
ψ _{JB}	Junction-to-board characterization parameter	67.4	79.3				
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	-	-	-		-	

- (1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics report, [SPRA953](#).

6.8 Thermal Information for LM2901x-Q1

THERMAL METRIC ⁽¹⁾		LM2901x-Q1		UNIT
		D (SOIC)	PW (TSSOP)	
		14 PINS	14 PINS	
R _{θJA}	Junction-to-ambient thermal resistance ⁽²⁾	88.6	119.1	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	49.1	47.9	°C/W
R _{θJB}	Junction-to-board thermal resistance	43.0	60.9	°C/W
ψ _{JT}	Junction-to-top characterization parameter	13.6	5.4	°C/W
ψ _{JB}	Junction-to-board characterization parameter	42.7	60.3	°C/W

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).
- (2) Maximum power dissipation is a function of T_{J(max)}, R_{θJA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_{J(max)} – T_A) / R_{θJA}. Operating at the absolute maximum T_J of 150°C can affect reliability.

6.9 Electrical Characteristics for LM2901B-Q1

$V_S = 5\text{ V}$, $V_{CM} = (V_-)$; $T_A = 25^\circ\text{C}$ (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{IO}	Input offset voltage	$V_S = 5\text{ to }36\text{ V}$	- 3.5	± 0.37	3.5	mV
		$V_S = 5\text{ to }36\text{ V}$, $T_A = -40^\circ\text{C to }+125^\circ\text{C}$	- 5.5		5.5	
I_B	Input bias current			- 3.5	- 25	nA
		$T_A = -40^\circ\text{C to }+125^\circ\text{C}$			- 50	nA
I_{OS}	Input offset current		- 25	± 0.5	25	nA
		$T_A = -40^\circ\text{C to }+125^\circ\text{C}$	- 50		50	nA
V_{CM}	Common mode range ⁽¹⁾	$V_S = 3\text{ to }36\text{ V}$	(V -)		(V+) - 1.5	V
		$V_S = 3\text{ to }36\text{ V}$, $T_A = -40^\circ\text{C to }+125^\circ\text{C}$	(V -)		(V+) - 2.0	V
A_{VD}	Large signal differential voltage amplification ⁽²⁾	$V_S = 15\text{ V}$, $V_O = 1.4\text{ V to }11.4\text{ V}$; $R_L \geq 15\text{ k}\Omega$ to (V+)	50	200		V/mV
V_{OL}	Low level output Voltage {swing from (V -)}	$I_{SINK} \leq 4\text{ mA}$, $V_{ID} = -1\text{ V}$		110	400	mV
		$I_{SINK} \leq 4\text{ mA}$, $V_{ID} = -1\text{ V}$ $T_A = -40^\circ\text{C to }+125^\circ\text{C}$			550	mV
I_{OH-LKG}	High-level output leakage current	(V+) = $V_O = 5\text{ V}$; $V_{ID} = 1\text{ V}$		0.1	50	nA
		(V+) = $V_O = 36\text{ V}$; $V_{ID} = 1\text{ V}$			100	nA
I_{OL}	Low level output current	$V_{OL} = 1.5\text{ V}$; $V_{ID} = -1\text{ V}$; $V_S = 5\text{ V}$	6	21		mA
I_Q	Quiescent current (all comparators)	$V_S = 5\text{ V}$, no load		0.8	1.2	mA
		$V_S = 36\text{ V}$, no load, $T_A = -40^\circ\text{C to }+125^\circ\text{C}$		1	1.6	mA

- (1) The voltage at either input should not be allowed to go negative by more than 0.3 V otherwise output may be incorrect and excessive input current can flow. The upper end of the common-mode voltage range is limited by $V_{CC} - 2\text{ V}$. However only one input needs to be in the valid common mode range, the other input can go up the maximum V_{CC} level and the comparator provides a proper output state. Either or both inputs can go to maximum V_{CC} level without damage.
- (2) This parameter is ensured by design and/or characterization and is not tested in production.

6.10 Switching Characteristics for LM2901B-Q1

$V_S = 5\text{ V}$, $V_{O_PULLUP} = 5\text{ V}$, $V_{CM} = V_S/2$, $C_L = 15\text{ pF}$, $R_L = 5.1\text{ k}\Omega$, $T_A = 25^\circ\text{C}$ (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{response}	Propagation delay time, high-to-low; Small scale input signal ⁽¹⁾	Input overdrive = 5mV, Input step = 100mV		1000		ns
t_{response}	Propagation delay time, high-to-low; TTL input signal ⁽¹⁾	TTL input with $V_{\text{ref}} = 1.4\text{ V}$		300		ns

- (1) High-to-low and low-to-high refers to the transition at the input.

6.11 Electrical Characteristics for LM2901x-Q1

$V_{CC} = 5\text{ V}$, at specified free-air temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS ⁽¹⁾		T_A ⁽²⁾	MIN	TYP	MAX	UNIT
V_{IO} Input offset voltage	$V_{IC} = V_{ICR(min)}$, $V_O = 1.4\text{ V}$, $V_{CC} = 5\text{ V}$ to MAX ⁽³⁾	Non A devices	25°C		2	7	mV
			Full range			15	
		A suffix devices	25°C		1	2	
			Full range			4	
I_{IO} Input offset current	$V_O = 1.4\text{ V}$		25°C		5	50	nA
			Full range			200	
I_{IB} Input bias current	$V_O = 1.4\text{ V}$		25°C		- 25	- 250	nA
			Full range			- 500	
V_{ICR} Common-mode input-voltage range ⁽⁴⁾			25°C	0	$V_{CC} - 1.5$		V
			Full range	0	$V_{CC} - 2$		
A_{VD} Large-signal differential-voltage amplification	$V_{CC} = 15\text{ V}$, $V_O = 1.4\text{ V}$ to 11.4 V , $R_L \geq 15\text{ k}\Omega$ to V_{CC}		25°C	25	100		V/mV
I_{OH} High-level output current	$V_{ID} = 1\text{ V}$	$V_{OH} = 5\text{ V}$	25°C		0.1	50	nA
		$V_{OH} = V_{CC} \text{ MAX}^{(3)}$	Full range			1	$\mu\text{ A}$
V_{OL} Low-level output voltage	$V_{ID} = - 1\text{ V}$	$I_{OL} = 4\text{ mA}$	25°C		150	400	mV
			Full range			700	
I_{OL} Low-level output current	$V_{ID} = - 1\text{ V}$	$V_{OL} = 1.5\text{ V}$	25°C	6	16		mA
I_{CC} Supply current (four comparators)	$V_O = 2.5\text{ V}$, No load	$V_{CC} = 5\text{ V}$	25°C		0.8	2	
		$V_{CC} = \text{MAX}^{(3)}$			1	2.5	

- (1) All characteristics are measured with zero common-mode input voltage, unless otherwise specified.
 (2) Full range (MIN to MAX) is -40°C to 125°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.
 (3) $V_{CC} \text{ MAX} = 30\text{ V}$ for non-V devices and 32 V for V-suffix devices.
 (4) The voltage at either the input or common mode should not be allowed to negative by more that 0.3 V. The upper end of the common-mode voltage range is $V_{CC+} - 1.5\text{ V}$; however, one input can exceed V_{CC} , and the comparator will provide a proper output state as long as the other input remains in the common-mode range. Either or both inputs can go to 30 V without damage.

6.12 Switching Characteristics for LM2901x-Q1

$V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
Response time ⁽²⁾	R_L connected to 5 V through $5.1\text{ k}\Omega$, $C_L = 15\text{ pF}^{(1)}$	100-mV input step with 5-mV overdrive		1.3		$\mu\text{ s}$
		TTL-level input step		0.3		

- (1) C_L includes probe and jig capacitance.
 (2) The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.

6.13 Typical Characteristics: LM2901B-Q1

$T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $R_{\text{PULLUP}} = 5.1\text{ k}$, $C_L = 15\text{ pF}$, $V_{\text{CM}} = 0\text{ V}$, $V_{\text{UNDERDRIVE}} = 100\text{ mV}$, $V_{\text{OVERDRIVE}} = 100\text{ mV}$ unless otherwise noted.

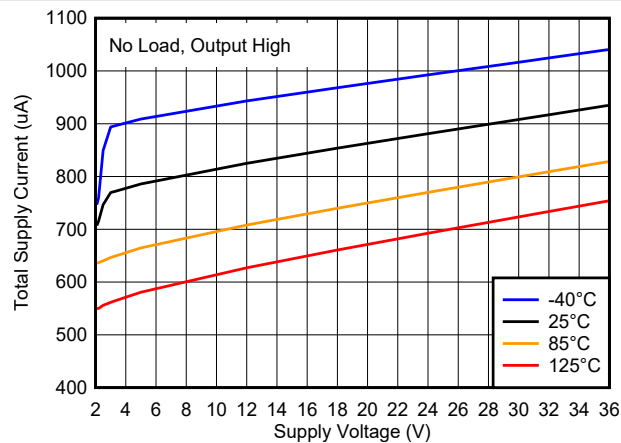


图 6-1. Total Supply Current vs. Supply Voltage

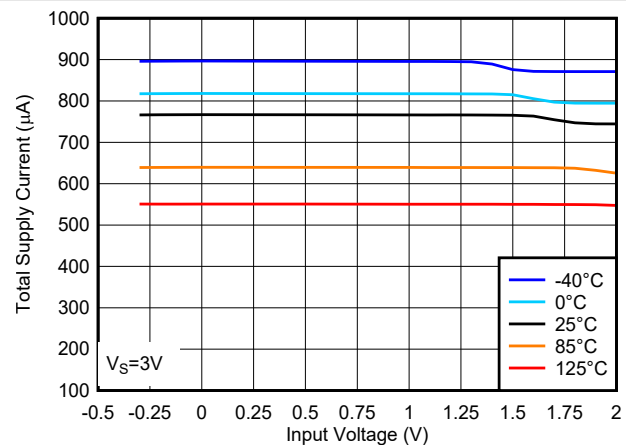


图 6-2. Total Supply Current vs. Input Voltage at 3V

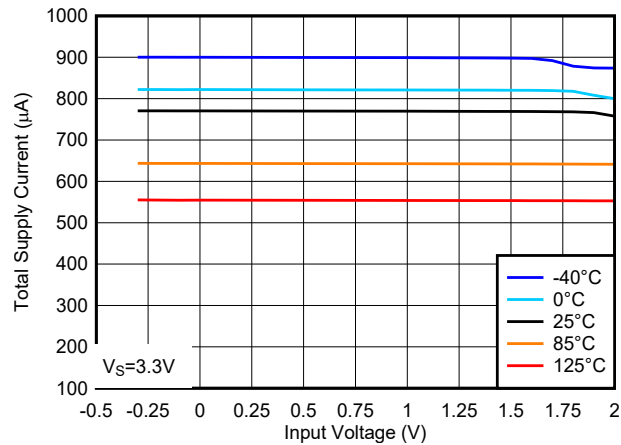


图 6-3. Total Supply Current vs. Input Voltage at 3.3V

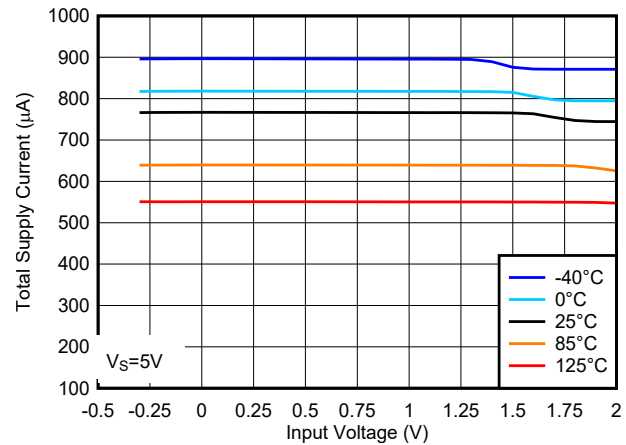


图 6-4. Total Supply Current vs. Input Voltage at 5V

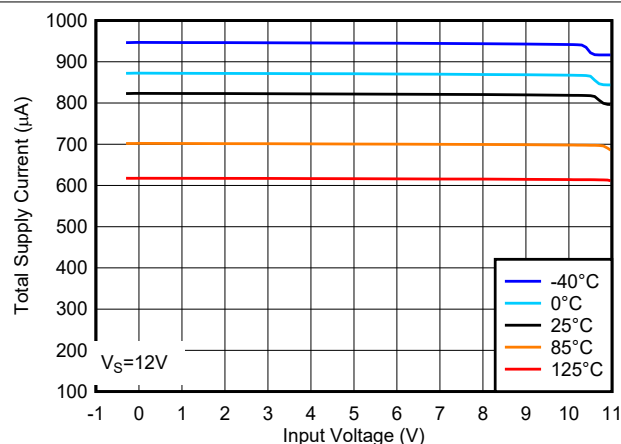


图 6-5. Total Supply Current vs. Input Voltage at 12V

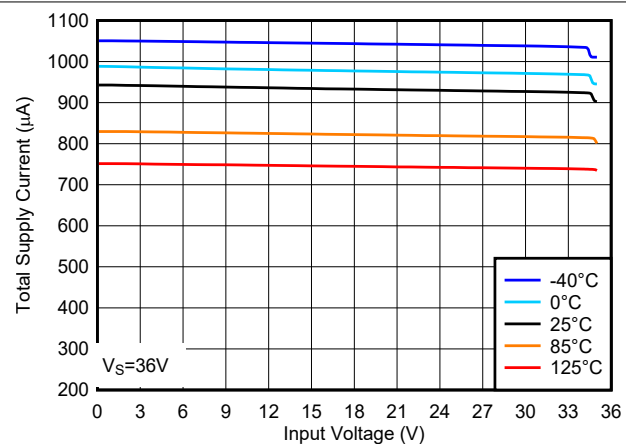


图 6-6. Total Supply Current vs. Input Voltage at 36V

6.13 Typical Characteristics: LM2901B-Q1 (continued)

$T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $R_{\text{PULLUP}} = 5.1\text{ k}$, $C_L = 15\text{ pF}$, $V_{\text{CM}} = 0\text{ V}$, $V_{\text{UNDERDRIVE}} = 100\text{ mV}$, $V_{\text{OVERDRIVE}} = 100\text{ mV}$ unless otherwise noted.

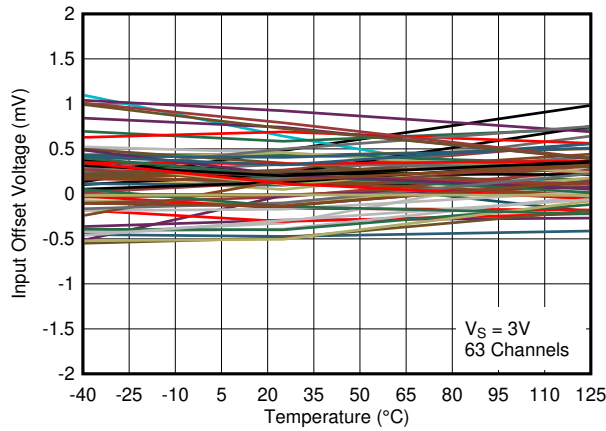


图 6-7. Input Offset Voltage vs. Temperature at 3V

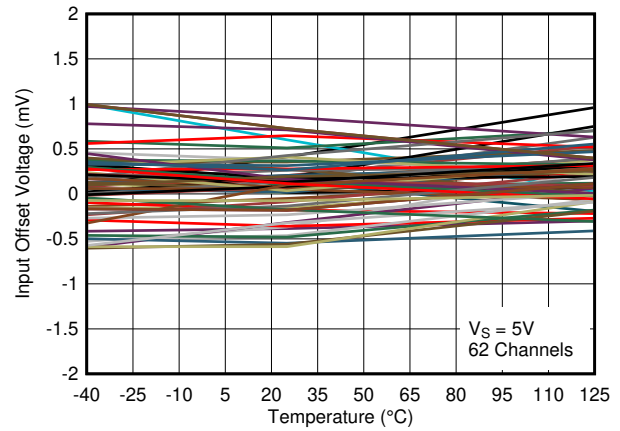


图 6-8. Input Offset Voltage vs. Temperature at 5V

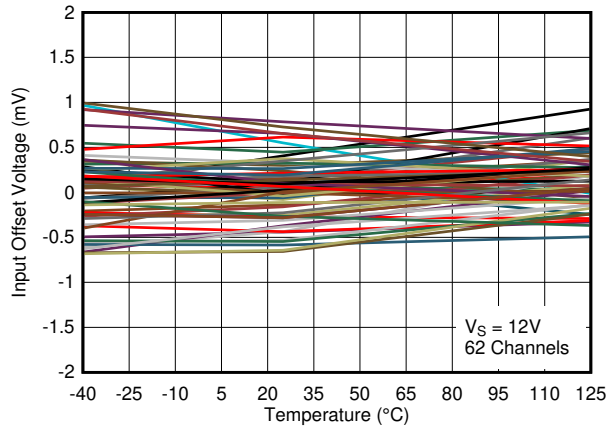


图 6-9. Input Offset Voltage vs. Temperature at 12V

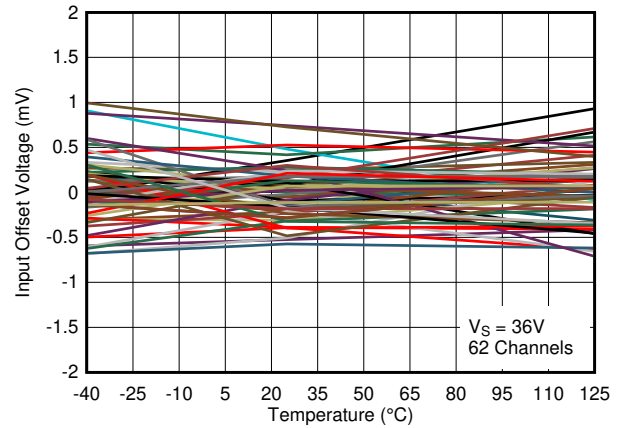


图 6-10. Input Offset Voltage vs. Temperature at 36V

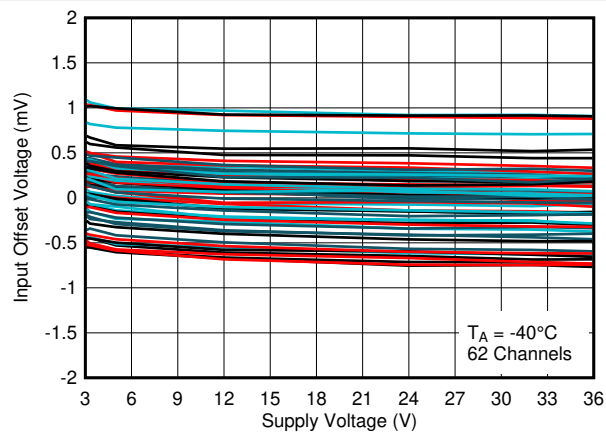


图 6-11. Input Offset Voltage vs. Supply Voltage at -40°C

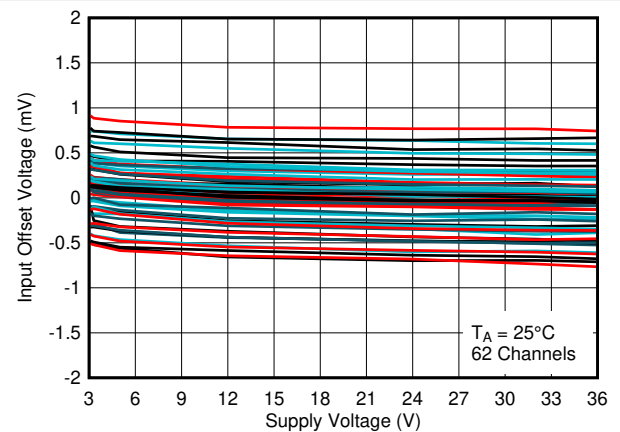


图 6-12. Input Offset Voltage vs. Supply Voltage at 25°C

6.13 Typical Characteristics: LM2901B-Q1 (continued)

$T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $R_{\text{PULLUP}} = 5.1\text{ k}$, $C_L = 15\text{ pF}$, $V_{\text{CM}} = 0\text{ V}$, $V_{\text{UNDERDRIVE}} = 100\text{ mV}$, $V_{\text{OVERDRIVE}} = 100\text{ mV}$ unless otherwise noted.

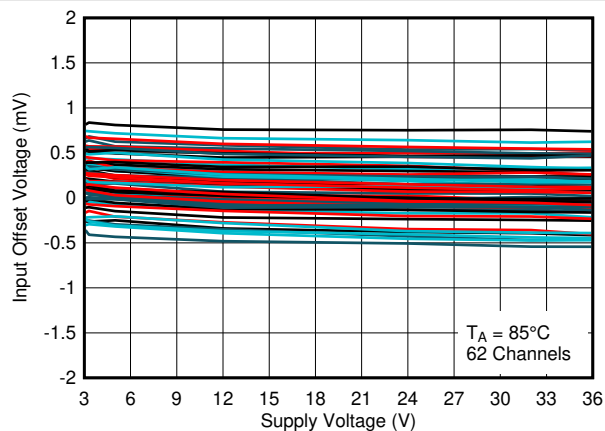


图 6-13. Input Offset Voltage vs. Supply Voltage at 85°C

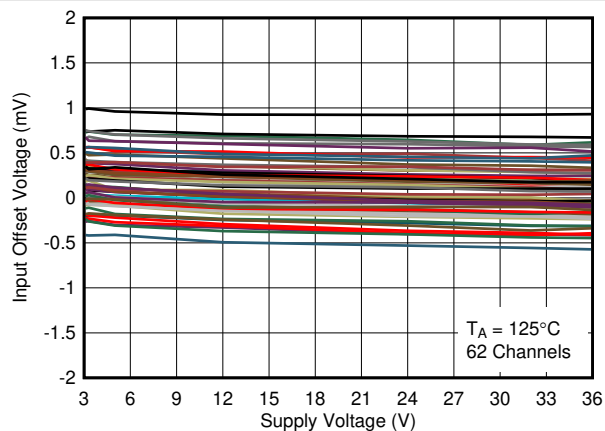


图 6-14. Input Offset Voltage vs. Supply Voltage at 125°C

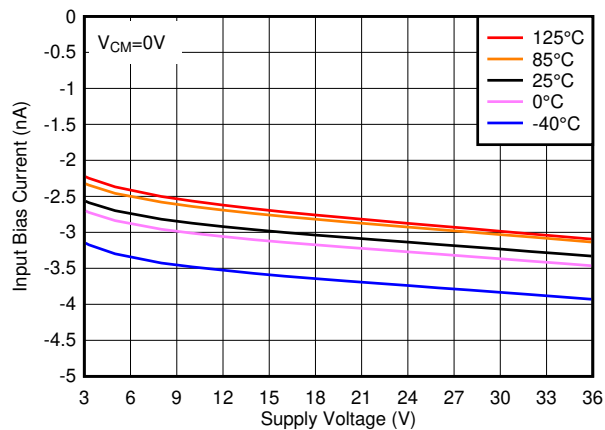


图 6-15. Input Bias Current vs. Supply Voltage

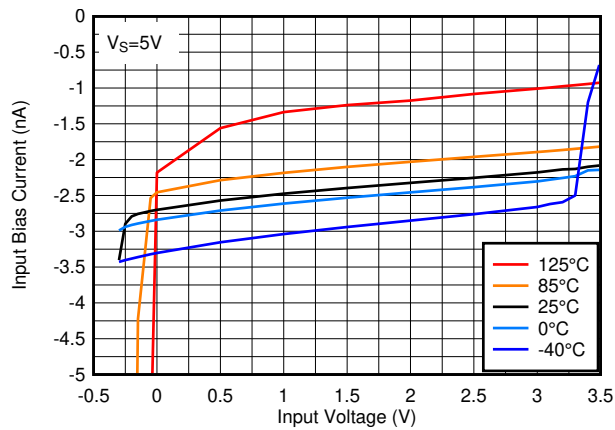


图 6-16. Input Bias Current vs. Input Voltage at 5V

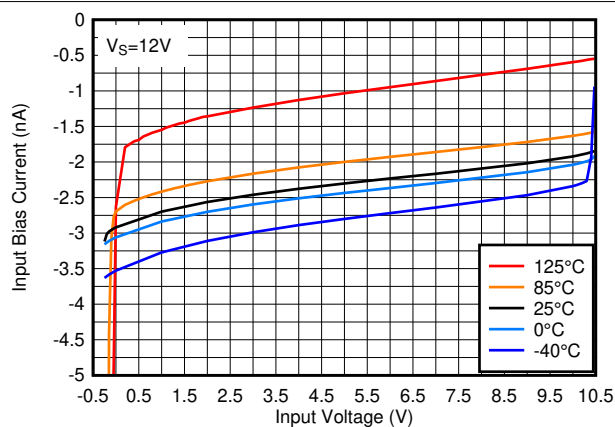


图 6-17. Input Bias Current vs. Input Voltage at 12V

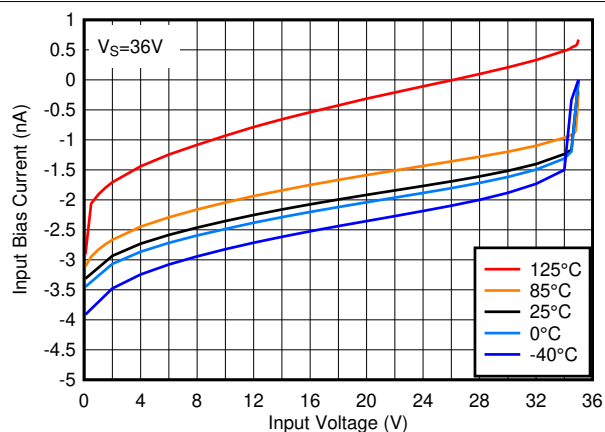


图 6-18. Input Bias Current vs. Input Voltage at 36V

6.13 Typical Characteristics: LM2901B-Q1 (continued)

$T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $R_{\text{PULLUP}} = 5.1\text{ k}$, $C_L = 15\text{ pF}$, $V_{\text{CM}} = 0\text{ V}$, $V_{\text{UNDERDRIVE}} = 100\text{ mV}$, $V_{\text{OVERDRIVE}} = 100\text{ mV}$ unless otherwise noted.

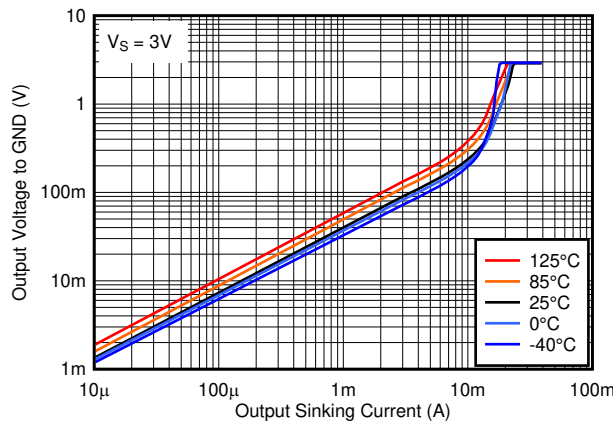


图 6-19. Output Low Voltage vs. Output Sinking Current at 3V

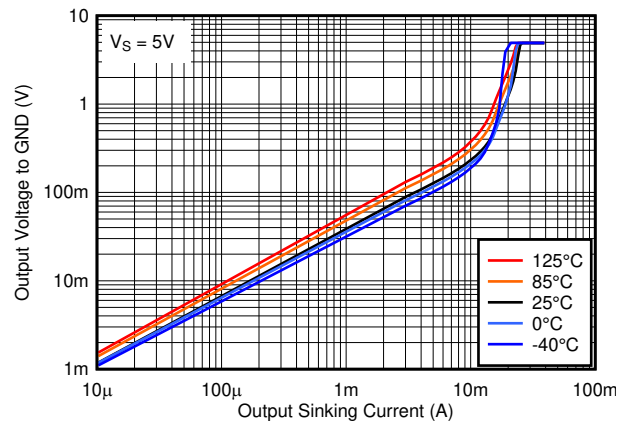


图 6-20. Output Low Voltage vs. Output Sinking Current at 5V

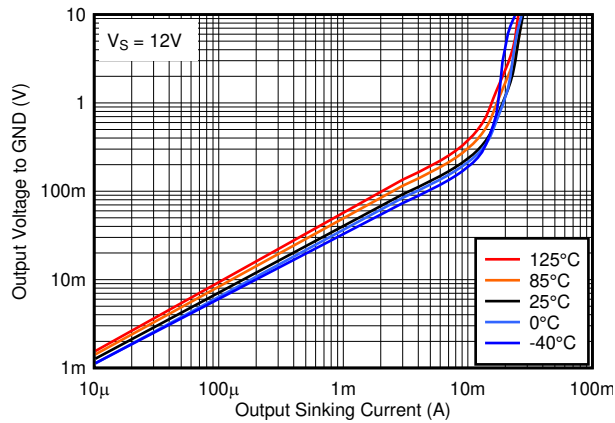


图 6-21. Output Low Voltage vs. Output Sinking Current at 12V

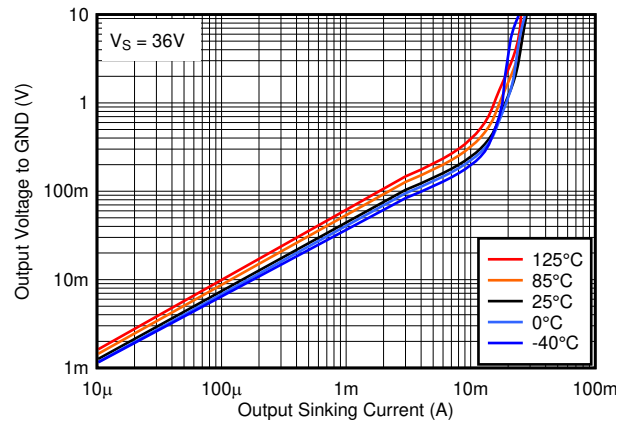


图 6-22. Output Low Voltage vs. Output Sinking Current at 36V

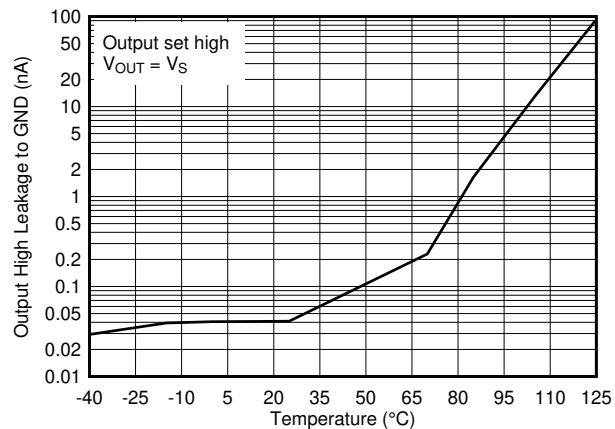


图 6-23. Output High Leakage Current vs. Temperature at 5V

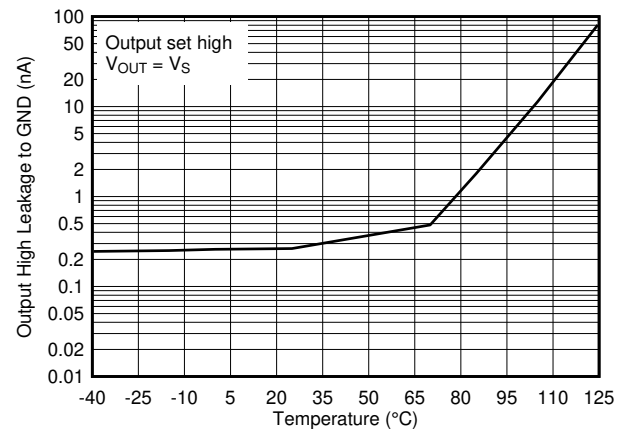


图 6-24. Output High Leakage Current vs. Temperature at 36V

6.13 Typical Characteristics: LM2901B-Q1 (continued)

$T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $R_{\text{PULLUP}} = 5.1\text{ k}$, $C_L = 15\text{ pF}$, $V_{\text{CM}} = 0\text{ V}$, $V_{\text{UNDERDRIVE}} = 100\text{ mV}$, $V_{\text{OVERDRIVE}} = 100\text{ mV}$ unless otherwise noted.

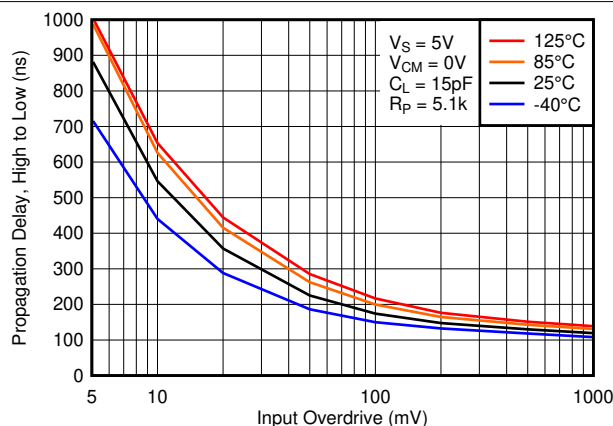


图 6-25. High to Low Propagation Delay vs. Input Overdrive Voltage, 5V

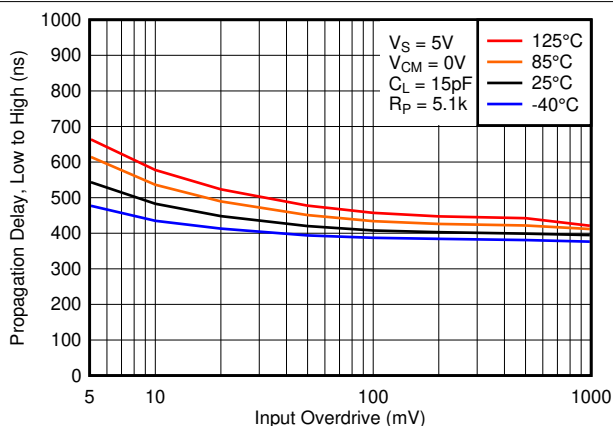


图 6-26. Low to High Propagation Delay vs. Input Overdrive Voltage, 5V

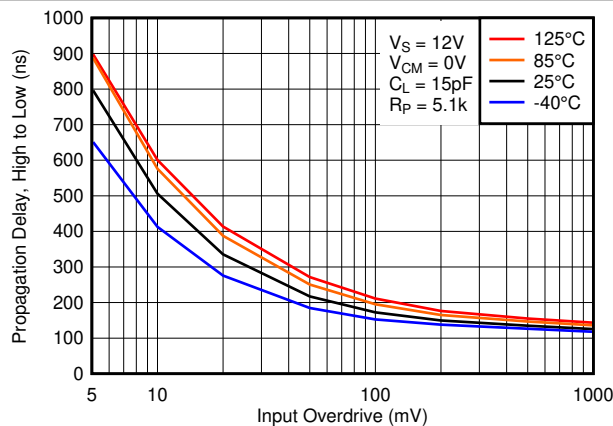


图 6-27. High to Low Propagation Delay vs. Input Overdrive Voltage, 12V

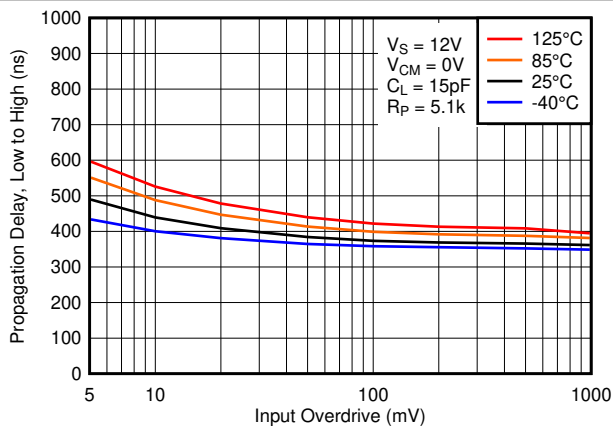


图 6-28. Low to High Propagation Delay vs. Input Overdrive Voltage, 12V

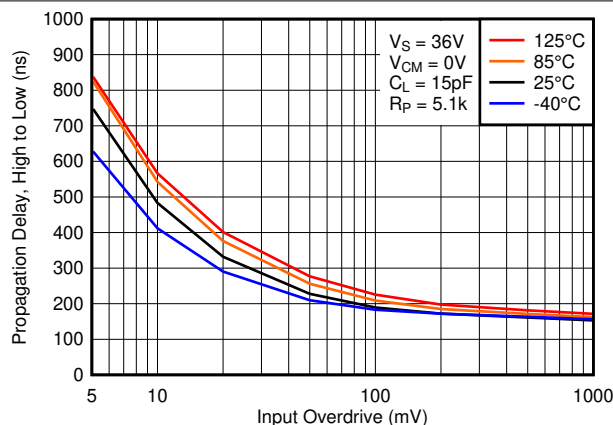


图 6-29. High to Low Propagation Delay vs. Input Overdrive Voltage, 36V

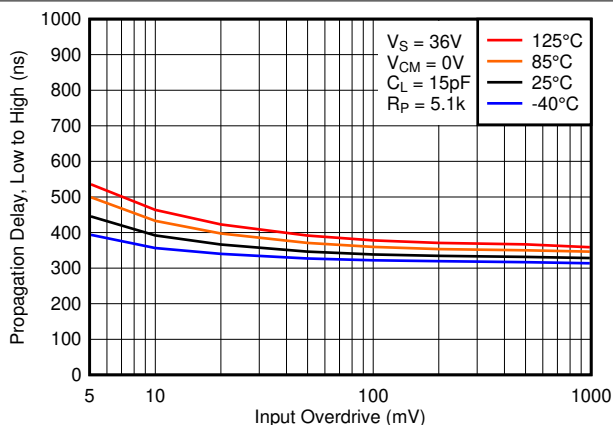


图 6-30. Low to High Propagation Delay vs. Input Overdrive Voltage, 36V

6.13 Typical Characteristics: LM2901B-Q1 (continued)

$T_A = 25^\circ\text{C}$, $V_S = 5\text{ V}$, $R_{\text{PULLUP}} = 5.1\text{ k}$, $C_L = 15\text{ pF}$, $V_{\text{CM}} = 0\text{ V}$, $V_{\text{UNDERDRIVE}} = 100\text{ mV}$, $V_{\text{OVERDRIVE}} = 100\text{ mV}$ unless otherwise noted.

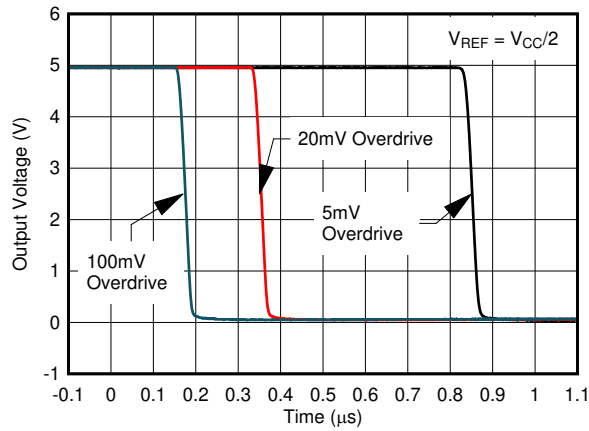


图 6-31. Response Time for Various Overdrives, High-to-Low Transition

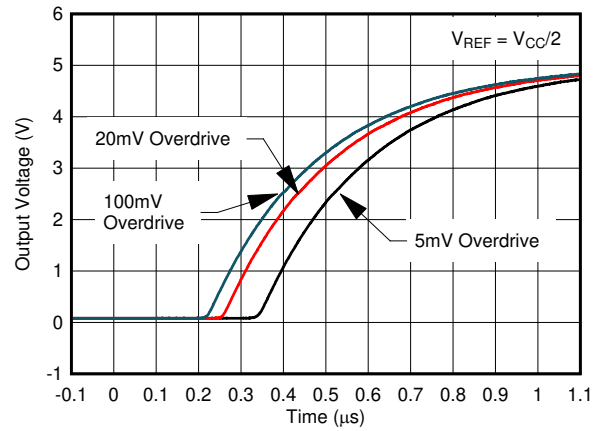


图 6-32. Response Time for Various Overdrives, Low-to-High Transition

6.14 Typical Characteristics: LM2901x-Q1

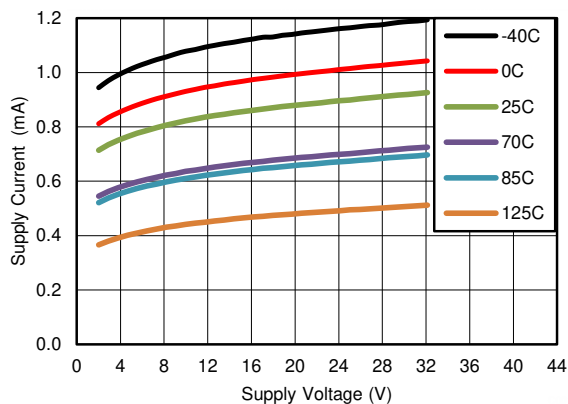


图 6-33. Supply Current vs Supply Voltage

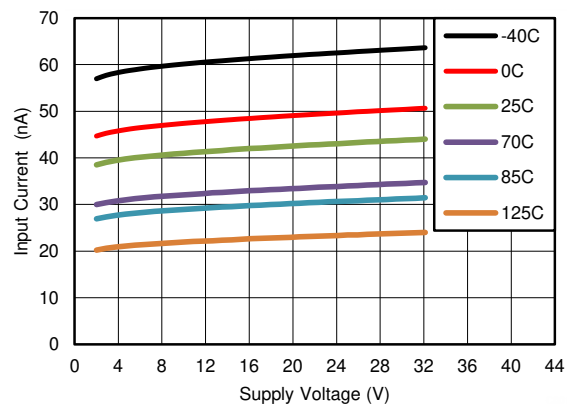


图 6-34. Input Bias Current vs Supply Voltage

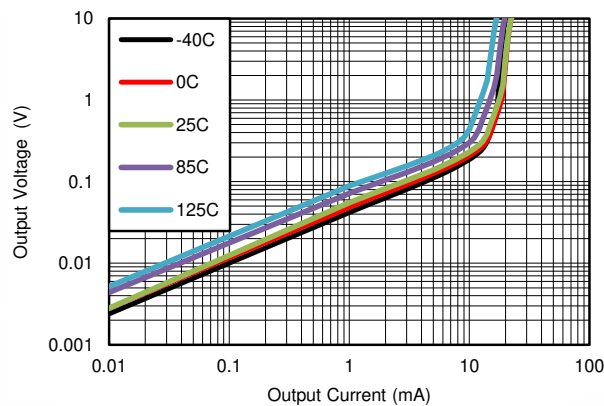


图 6-35. Output Saturation Voltage

7 Detailed Description

7.1 Overview

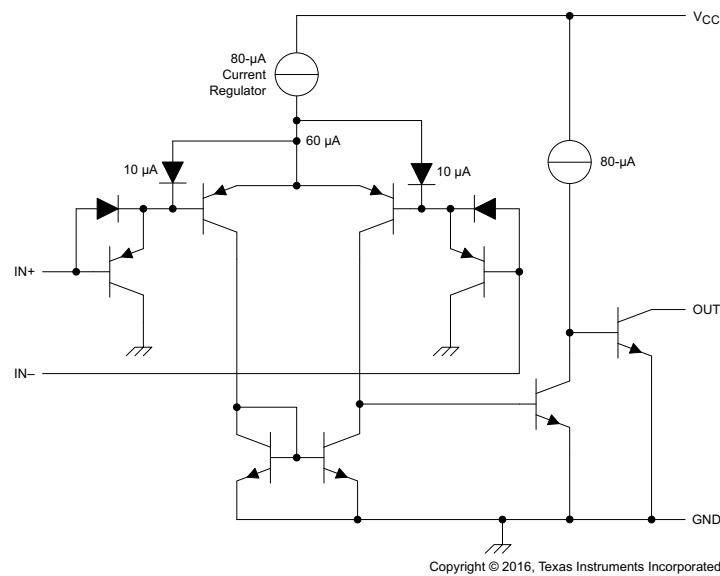
The LM2901-Q1 family is a quad comparator with the ability to operate up to 36 V on the supply pin. This standard device has proven ubiquity and versatility across a wide range of applications. This is due to its very wide supply voltages range (2 V to 36 V), low I_q and fast response.

This device is AEC-Q100 qualified and can operate over a wide temperature range of -40°C to 125°C .

The open-drain output allows the user to configure the output's logic low voltage (V_{OL}) and can be utilized to enable the comparator to be used in AND functionality.

The "B" versions add dedicated ESD protections on all the pins for improved ESD performance as well as improved negative input voltage handling. Please see Application Note [SNOAA35](#) for more information

7.2 Functional Block Diagram



7.3 Feature Description

LM2901-Q1 family consists of a PNP Darlington pair input, allowing the device to operate with very high gain and fast response with minimal input bias current. The input Darlington pair creates a limit on the input common mode voltage capability, allowing LM2901-Q1 to accurately function from ground to $V_{CC} - 1.5\text{V}$ differential input. This enables much head room for modern day supplies of 3.3 V and 5.0 V.

The output consists of an open drain NPN (pull-down or low side) transistor. The output NPN will sink current when the negative input voltage is higher than the positive input voltage and the offset voltage. The V_{OL} is resistive and will scale with the output current. Please see [图 6-19](#), [图 6-20](#) and [图 6-21](#) for V_{OL} values with respect to the output current.

The special pinout of this device separates input pins from the output pins to reduce parasitic coupling between input and output.

7.4 Device Functional Modes

7.4.1 Voltage Comparison

The LM2901-Q1 family of devices operates solely as a voltage comparator, comparing the differential voltage between the positive and negative pins and outputs a logic low or high impedance (logic high with pullup) based on the input differential polarity.

8 Application and Implementation

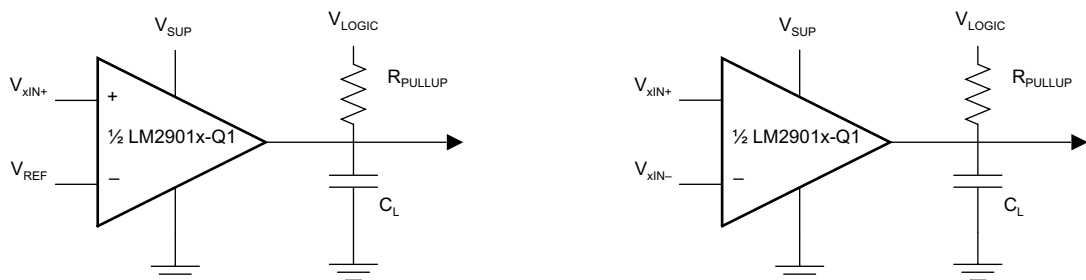
备注

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

8.1 Application Information

LM2901-Q1 family will typically be used to compare a single signal to a reference or two signals against each other. Many users take advantage of the open drain output to drive the comparison logic output to a logic voltage level to an MCU or logic device. The wide supply range and high voltage capability makes LM2901-Q1 optimal for level shifting to a higher or lower voltage.

8.2 Typical Application



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图 8-1. Single-Ended and Differential Comparator Configurations

8.2.1 Design Requirements

For this design example, use the parameters listed in 表 8-1 as the input parameters.

表 8-1. Design Parameters

PARAMETER	EXAMPLE VALUE
Input voltage range	0 V to $V_{SUP} - 1.5$ V
Supply voltage	2 V to 36 V
Logic supply voltage	2 V to 36 V
Output current (R_{PULLUP})	1 μ A to 20 mA
Input overdrive voltage	100 mV
Reference voltage	2.5 V
Load capacitance (C_L)	15 pF

8.2.2 Detailed Design Procedure

8.2.2.1 Input Voltage Range

When choosing the input voltage range, the input common mode voltage range (V_{ICR}) must be taken in to account. If temperature operation is above or below 25°C the V_{ICR} can range from 0 V to $V_{CC} - 2.0$ V. This limits the input voltage range to as high as $V_{CC} - 2.0$ V and as low as 0 V. Operation outside of this range can yield incorrect comparisons.

Below is a list of input voltage situation and their outcomes:

1. When both IN- and IN+ are both within the common mode range:
 - a. If IN- is higher than IN+ and the offset voltage, the output is low and the output transistor is sinking current

- b. If IN- is lower than IN+ and the offset voltage, the output is high impedance and the output transistor is not conducting
2. When IN- is higher than common mode and IN+ is within common mode, the output is low and the output transistor is sinking current
3. When IN+ is higher than common mode and IN- is within common mode, the output is high impedance and the output transistor is not conducting
4. When IN- and IN+ are both higher than common mode, the output is low and the output transistor is sinking current. The "B" version output will go high.

8.2.2.2 Minimum Overdrive Voltage

The overdrive voltage is the differential voltage produced between the positive and negative inputs of the comparator over the offset voltage (V_{IO}). To make an accurate comparison the overdrive voltage (V_{OD}) must be higher than the input offset voltage (V_{IO}). The overdrive voltage can also determine the response time of the comparator, with the response time decreasing as the overdrive increases. 图 8-2 and 图 8-3 show positive and negative response times with respect to overdrive voltage.

8.2.2.3 Output and Drive Current

Output current is determined by the load/pull-up resistance and logic/pull-up voltage. The output current will produce an output low voltage (V_{OL}) which is proportional to the output current. Use 图 6-19, 图 6-20, and 图 6-21 to determine V_{OL} based on the output current.

The output current can also effect the transient response. More will be explained in the next section.

8.2.2.4 Response Time

The transient response can be determined by the load capacitance (C_L), load or pullup resistance (R_{PULLUP}), and equivalent collector-emitter resistance (R_{CE}).

Use 方程式 1 and 方程式 2 to calculate the approximate values of the rise time (t_r) and fall time (t_f).

$$t_P \approx R_{PULLUP} \times C_L \quad (1)$$

$$t_N \approx R_{CE} \times C_L \quad (2)$$

To find the value of R_{CE} , use the slope of 图 6-35 in the linear region at the desired temperature, or divide V_{OL} by I_O .

8.2.3 Application Curves

The following curves were generated with 5 V on V_{CC} and V_{LOGIC} , $R_{PULLUP} = 5.1 \text{ k}\Omega$, and 50-pF scope probe.

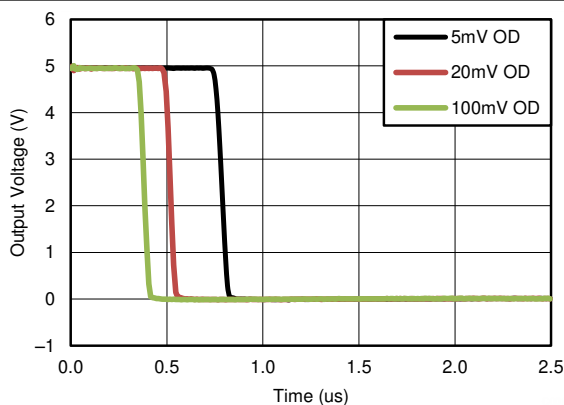


图 8-2. Response Time for Various Overdrives Negative Transition

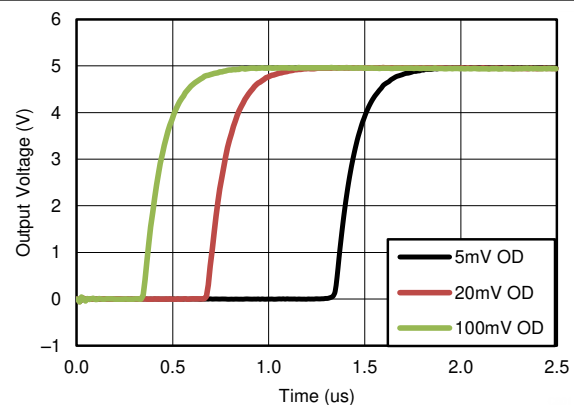


图 8-3. Response Time for Various Overdrives Positive Transition

9 Power Supply Recommendations

For fast response and comparison applications with noisy or AC inputs, TI recommends using a bypass capacitor on the supply pin to reject any variation on the supply voltage. This variation can take away from some of the input common mode range of the comparator and create an inaccurate comparison.

10 Layout

10.1 Layout Guidelines

For accurate comparator applications without hysteresis it is important maintain a stable power supply with minimized noise and glitches, which can affect the high level input common mode voltage range. In order to achieve this, it is best to add a bypass capacitor between the supply voltage and ground. This should be implemented on the positive power supply and negative supply (if available).

10.2 Layout Example

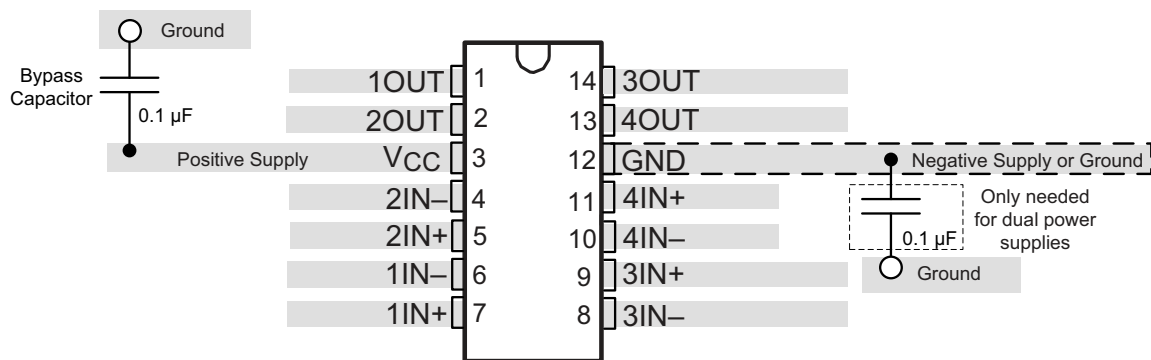


图 10-1. LM2901x-Q1 Layout Example

11 Device and Documentation Support

11.1 Documentation Support

11.1.1 Related Documentation

For related documentation, see the following:

TL331-Q1 *Single Differential Comparator*, [SLVS969](#)

11.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

表 11-1. Related Links

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
LM2901-Q1	Click here	Click here	Click here	Click here	Click here
LM2901V-Q1	Click here	Click here	Click here	Click here	Click here
LM2901AV-Q1	Click here	Click here	Click here	Click here	Click here
LM2901B-Q1	Click here	Click here	Click here	Click here	Click here

11.3 Trademarks

所有商标均为其各自所有者的财产。

11.4 静电放电警告



静电放电 (ESD) 会损坏这个集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

11.5 术语表

[TI 术语表](#) 本术语表列出并解释了术语、首字母缩略词和定义。

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM2901AVQDRQ1	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901AVQ	Samples
LM2901AVQPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901AVQ	Samples
LM2901AVQPWRQ1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901AVQ	Samples
LM2901BQDRQ1	ACTIVE	SOIC	D	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM2901BQ	Samples
LM2901BQPWRQ1	ACTIVE	TSSOP	PW	14	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901BQ	Samples
LM2901BWRTERQ1	ACTIVE	WQFN	RTE	16	5000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901BQ	Samples
LM2901QDRG4Q1	LIFEBUY	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901Q1	
LM2901QDRQ1	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901Q1	Samples
LM2901QPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901Q1	Samples
LM2901QPWRQ1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901Q1	Samples
LM2901VQDRQ1	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901VQ1	Samples
LM2901VQPWRG4Q1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901VQ	Samples
LM2901VQPWRQ1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	2901VQ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- ⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- ⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- ⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- ⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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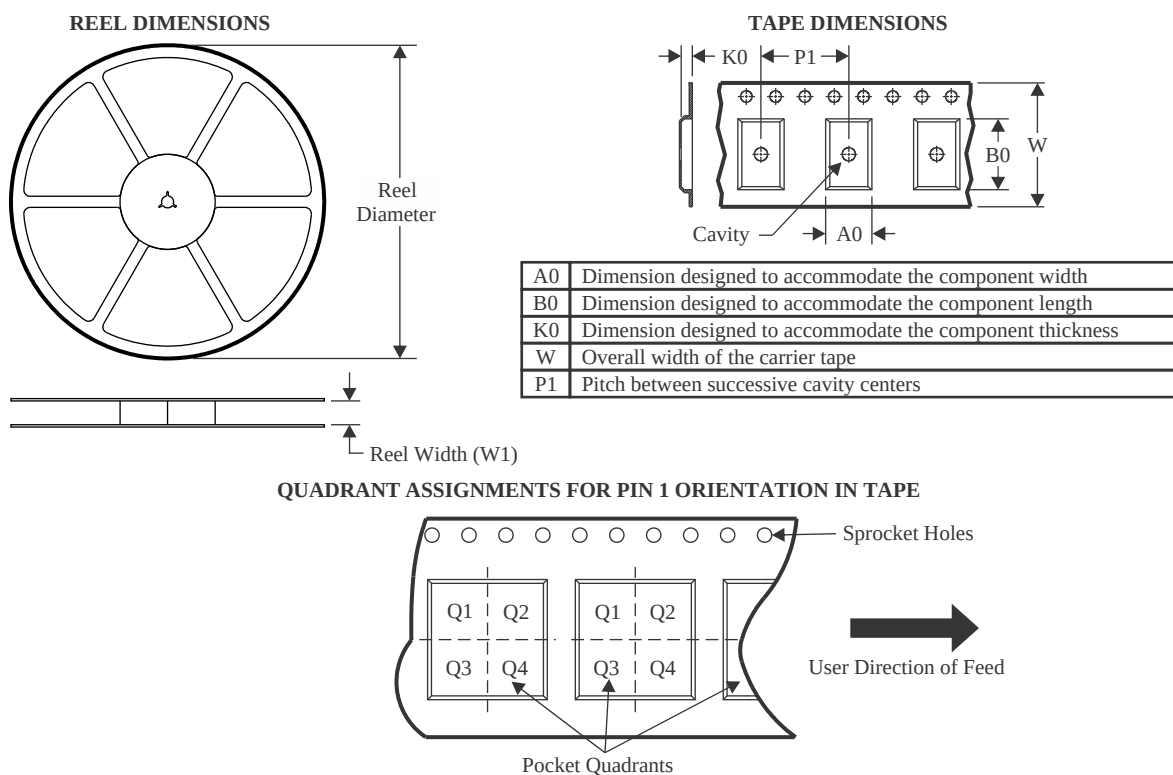
OTHER QUALIFIED VERSIONS OF LM2901-Q1, LM2901AV-Q1, LM2901B-Q1, LM2901V-Q1 :

- Catalog : [LM2901](#), [LM2901AV](#), [LM2901B](#), [LM2901V](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

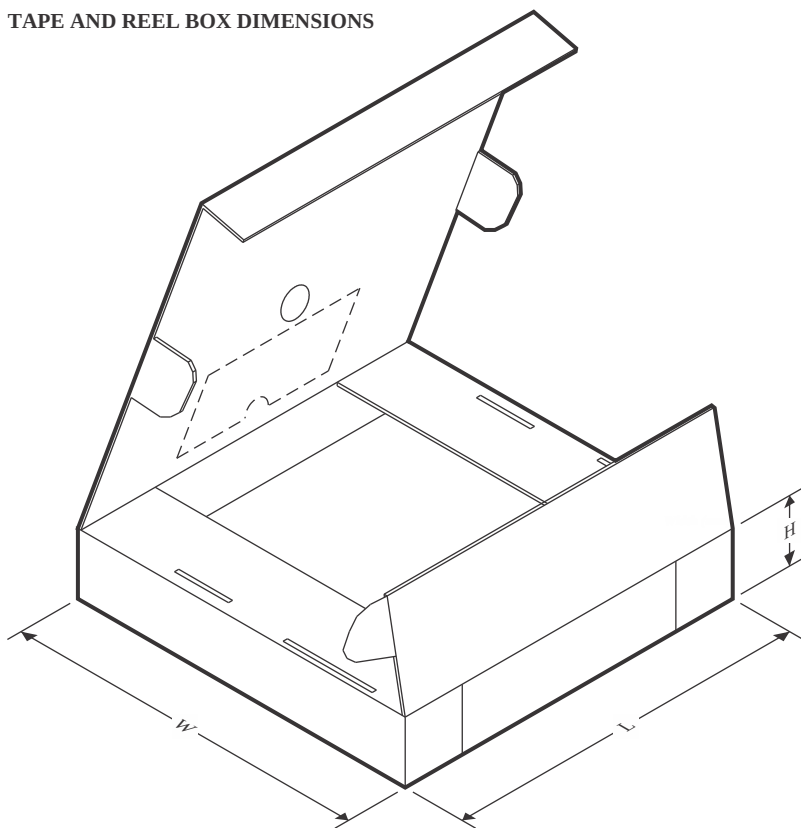
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2901AVQPWRG4Q1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2901AVQPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2901BQDRQ1	SOIC	D	14	3000	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
LM2901BQPWRQ1	TSSOP	PW	14	3000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2901BWRTERQ1	WQFN	RTE	16	5000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
LM2901QPWRG4Q1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2901QPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2901VQPWRG4Q1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
LM2901VQPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS

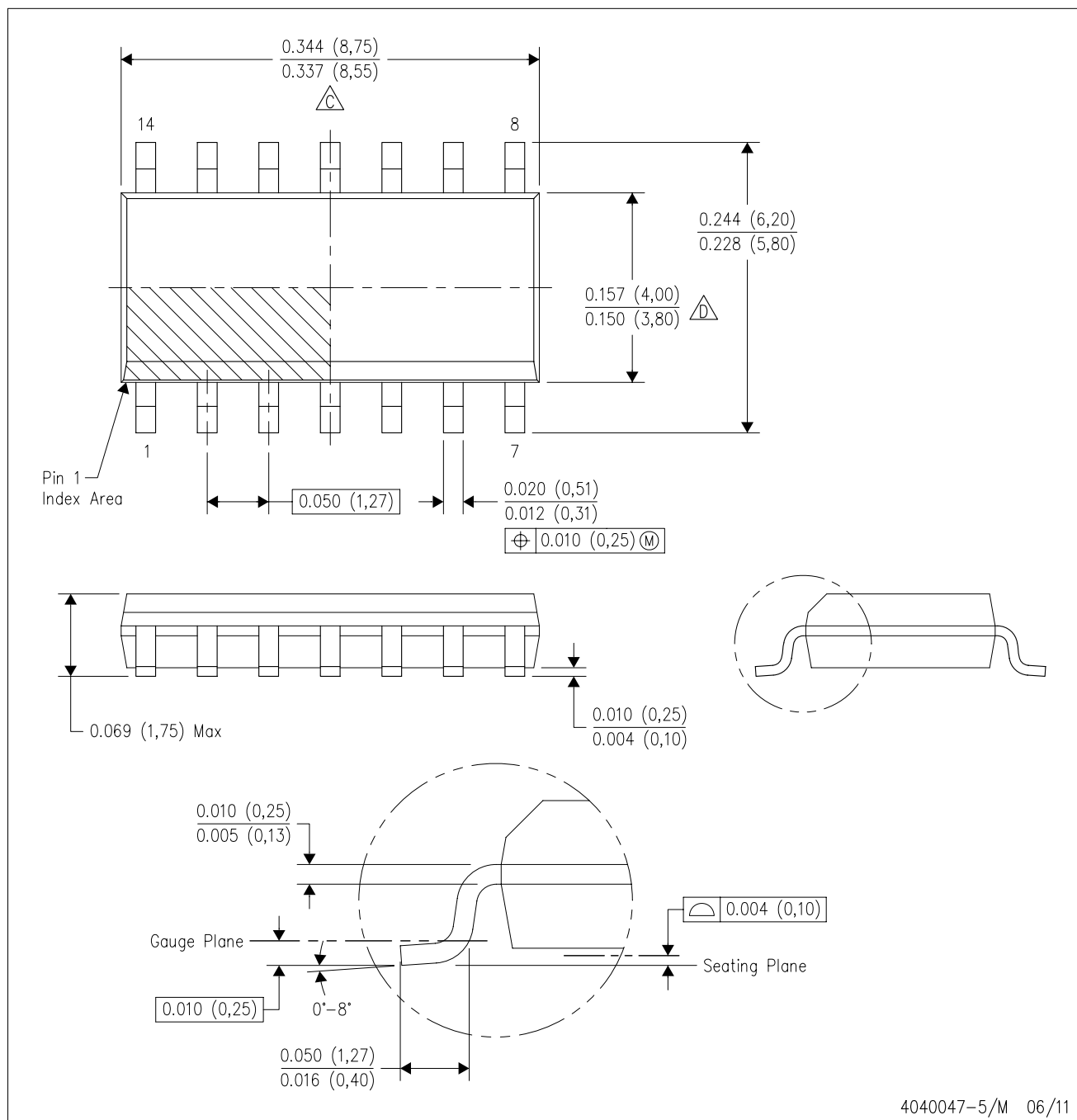


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2901AVQPWRG4Q1	TSSOP	PW	14	2000	367.0	367.0	35.0
LM2901AVQPWRQ1	TSSOP	PW	14	2000	356.0	356.0	35.0
LM2901BQDRQ1	SOIC	D	14	3000	356.0	356.0	35.0
LM2901BQPWRQ1	TSSOP	PW	14	3000	356.0	356.0	35.0
LM2901BWRTERQ1	WQFN	RTE	16	5000	367.0	367.0	35.0
LM2901QPWRG4Q1	TSSOP	PW	14	2000	367.0	367.0	35.0
LM2901QPWRQ1	TSSOP	PW	14	2000	356.0	356.0	35.0
LM2901VQPWRG4Q1	TSSOP	PW	14	2000	367.0	367.0	35.0
LM2901VQPWRQ1	TSSOP	PW	14	2000	356.0	356.0	35.0

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



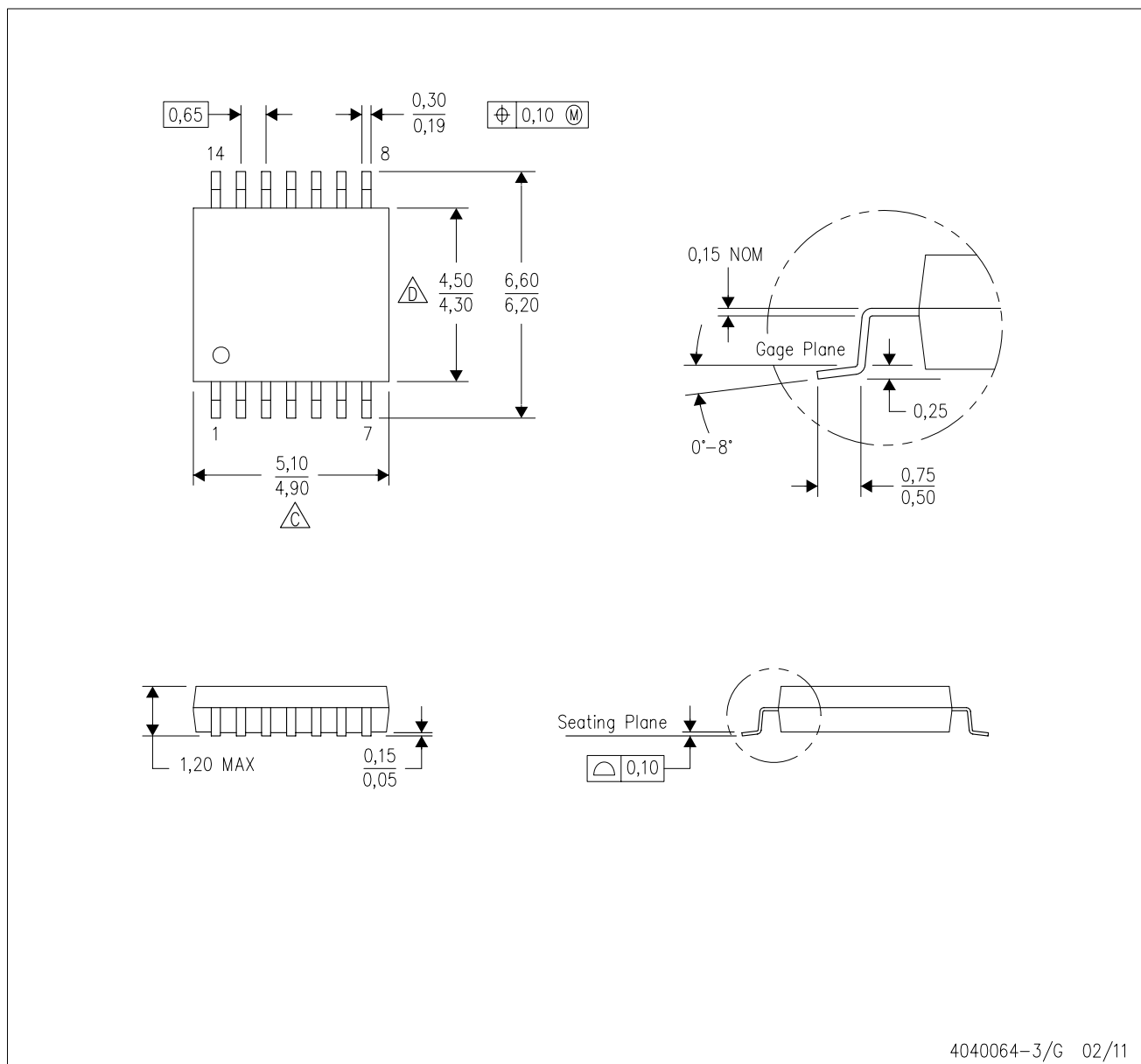
4040047-5/M 06/11

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



GENERIC PACKAGE VIEW

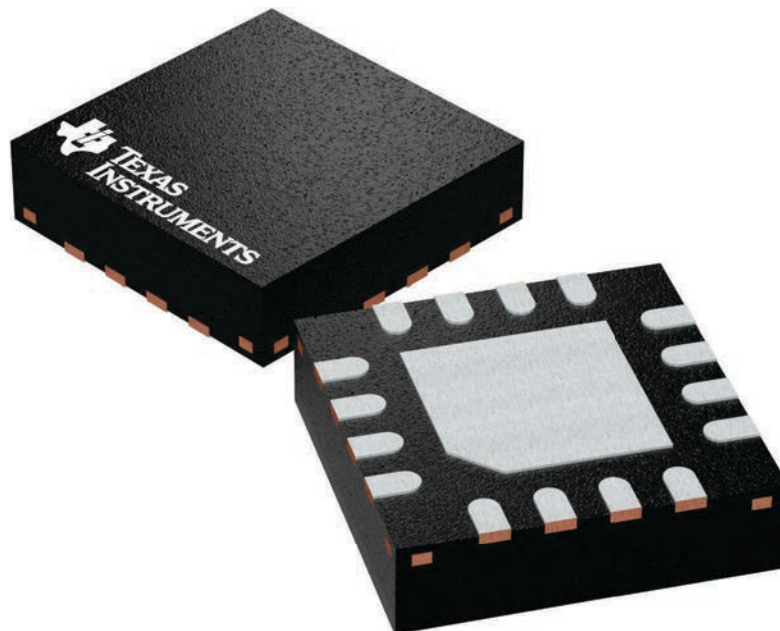
RTE 16

WQFN - 0.8 mm max height

3 x 3, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4225944/A

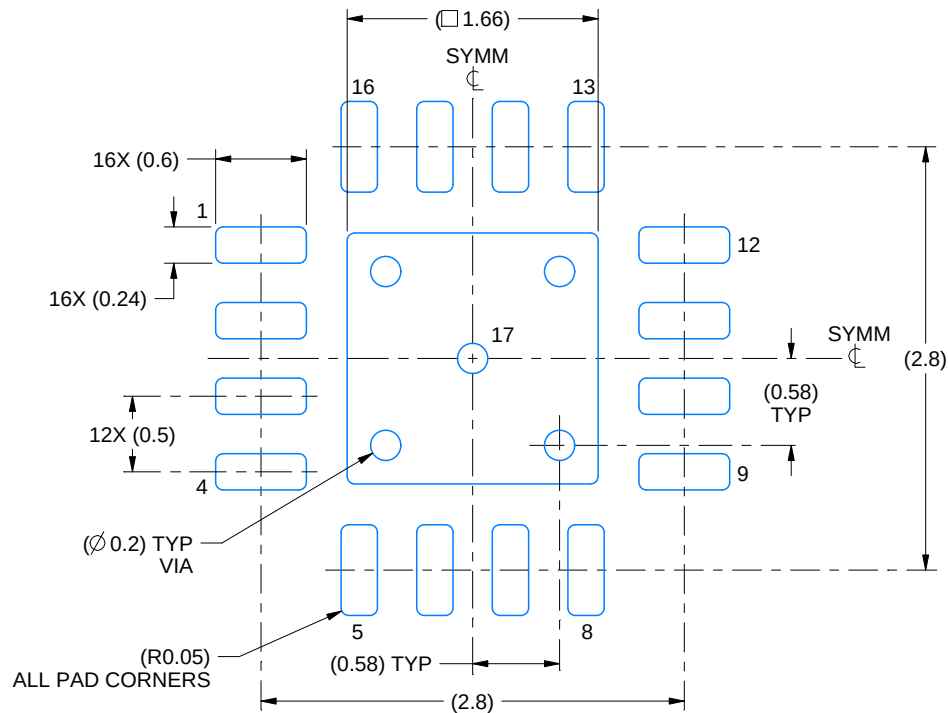


1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

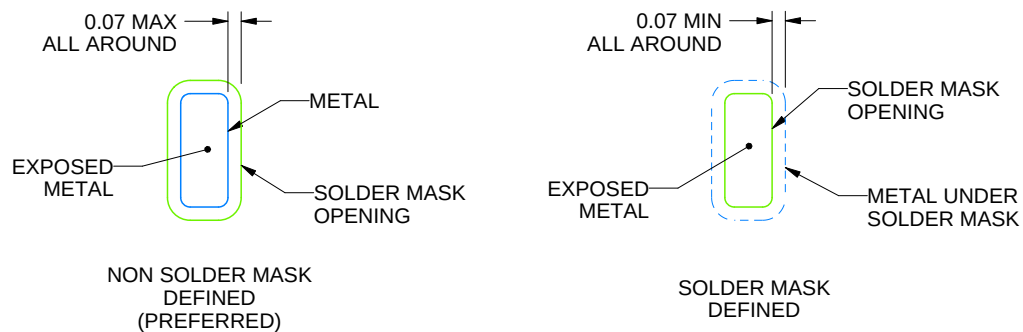
RTE0016K

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:20X



SOLDER MASK DETAILS

4224938/C 03/2022

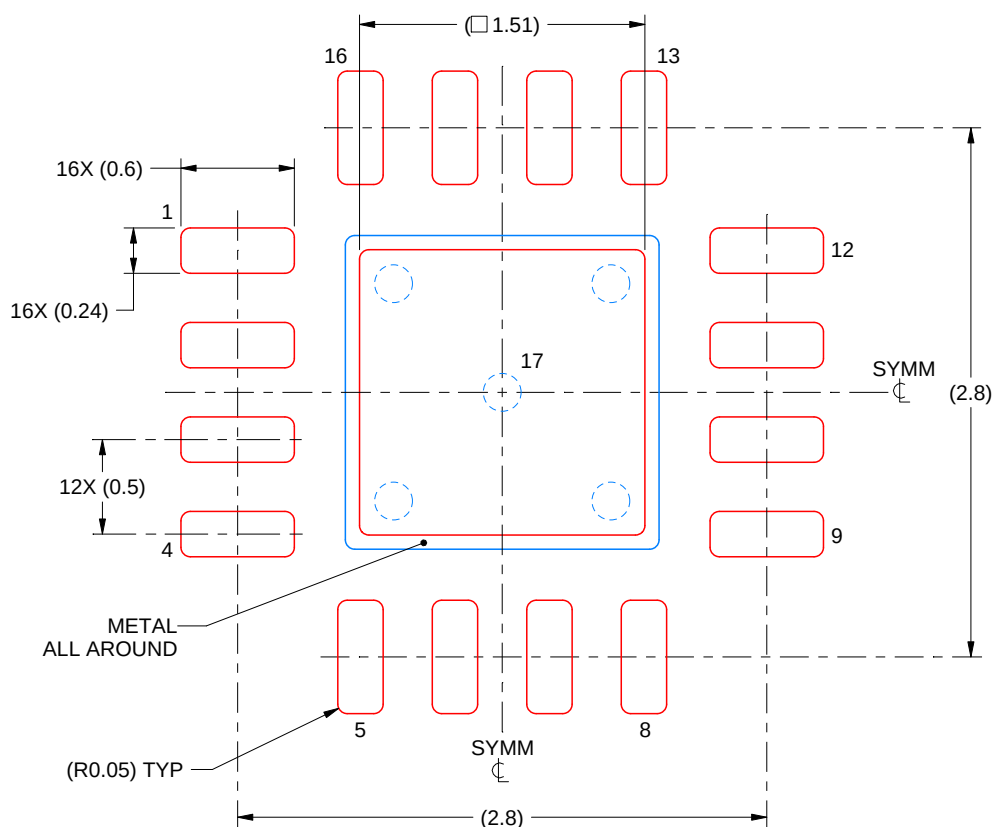
NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

RTE0016K

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 17:
84% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:25X

4224938/C 03/2022

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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